

ZMOD4510

Gas Sensor Module for Nitrogen Dioxide and Ozone

The ZMOD4510 Gas Sensor Module detects air quality in a variety of indoor and outdoor applications. The module works reliably in various conditions, including very humid and dusty applications with the possibility of water spray, condensation, or immersion. The small LGA assembly consists of a gas sensing element and a CMOS signal conditioning IC. The sensing element is a Si-based microhotplate with a robust and highly sensitive metal oxide (MOx) chemiresistor. The signal conditioner controls the sensor temperature and measures the MOx resistance, which is a function of the gas concentration. The measurement results are easily read using an I²C interface with the user's microprocessor, which processes the data.

The device is ideal for monitoring and reporting air quality based on nitrogen dioxide (NO₂) and ozone (O₃) concentrations which are typical outdoor air pollutants. Free firmware is provided with algorithms based on machine learning containing an embedded artificial intelligence (AI). The algorithms are used to determine concentration levels and are calculated based on the Air Quality Index (AQI) output according to international standards. The ZMOD4510 can measure selectively nitrogen dioxide and ozone. With its Ultra-Low Power mode, the ZMOD4510 is an excellent choice for low-voltage and low-power battery applications.

Typical Applications

- Air monitoring for nitrogen dioxide and ozone
- Detect unhealthy conditions in indoor and outdoor air
- Personal air quality monitors
- Smart City instrumentation
- Road/City emission control
- Automation based on AQI (HVAC systems, building air purification systems)
- Monitor home, office, public building, personal, and bathroom environments for healthy conditions and comfort
- Ideal for mobile, industrial, and consumer applications
- Boiler and heater control
- Weather station

Features

- Sensor output based on AI machine learning algorithm provides selective measurements of:
 - Nitrogen dioxide (NO₂), Ozone (O₃)
 - Ozone (O₃) using Ultra-Low Power (ULP)
- Supports international standards for air quality, such as the US Environmental Protection Agency (air quality index based on EPA)
- Heater driver and regulation loop for constant resistance, minimizing effect of environmental temperature on signal
- Built-in non-volatile memory (NVM) for module-specific data (configuration and calibration)
- Ultra-low average power consumption down to 0.22mW
- Excellent for low-voltage and low-power battery applications
- No external trimming components required
- External reset pin (active-LOW)
- Siloxane resistant
- JEDEC JESD47 qualified for 10 years lifetime
- Supply voltage: 1.7V to 3.6V
- RoHS compliant
- Water and dustproof version available (IP67 certified)
- Package: 12-LGA. Available assembly sizes:
 - 3.0 × 3.0 × 0.7 mm (Standard version)
 - 3.0 × 3.0 × 0.9 mm (IP67 version)

Available Support

- Evaluation kits for USB and PMOD™ board
- Manuals, application notes, blog, and white papers
- Instructional videos
- Programming libraries, example codes, and algorithm support to optimize performance

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1. Overview

1.1 Block Diagram

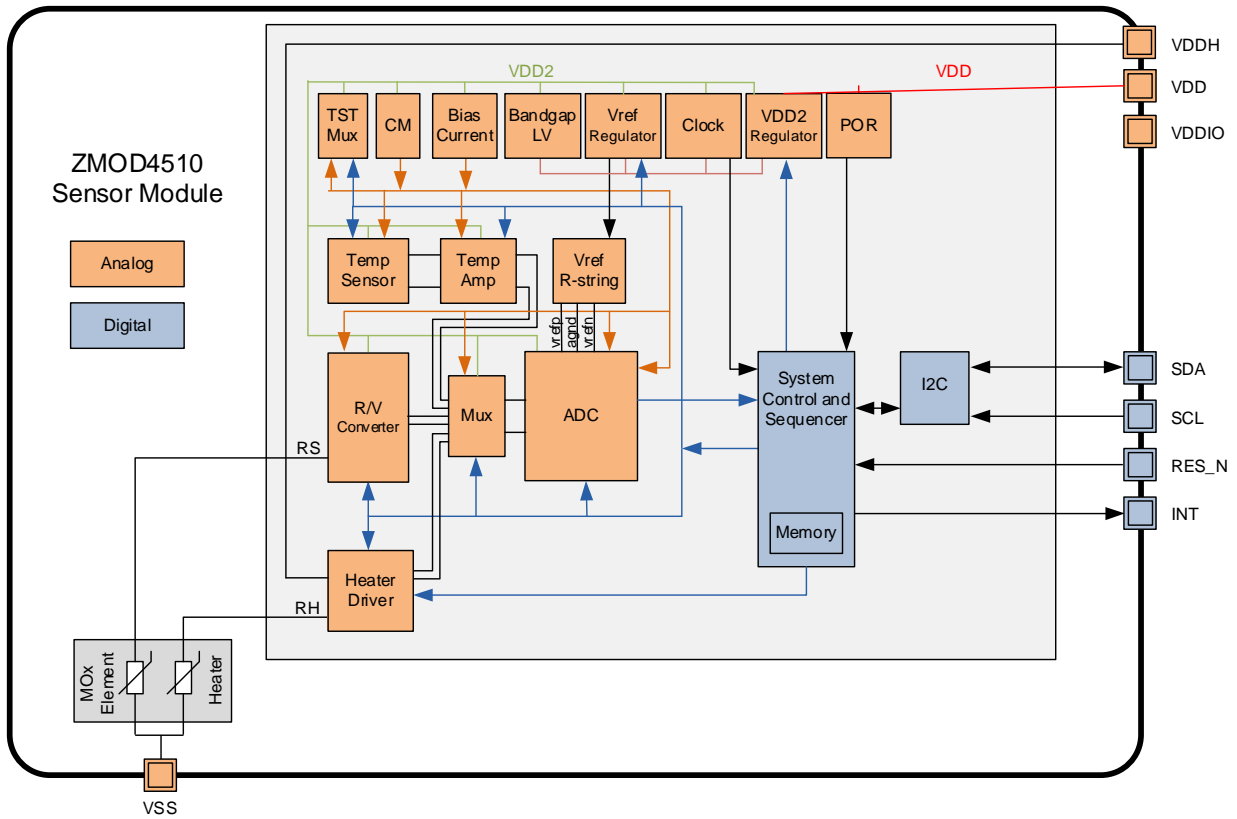


Figure 1. Block Diagram

Note: For definitions of abbreviations, see “Glossary”.

1.2 Application Circuit

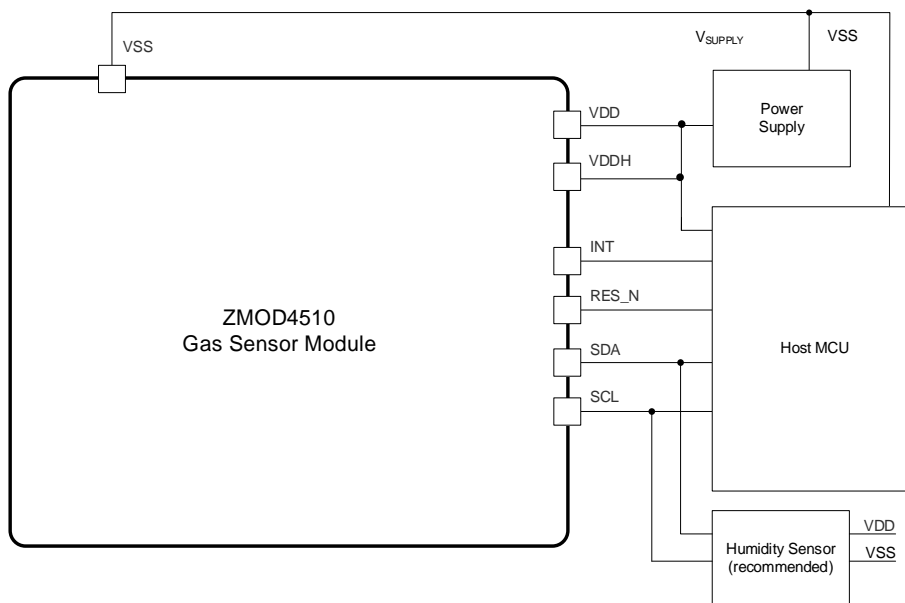


Figure 2. Application Circuit

2. Pin Information

2.1 Pin Assignments

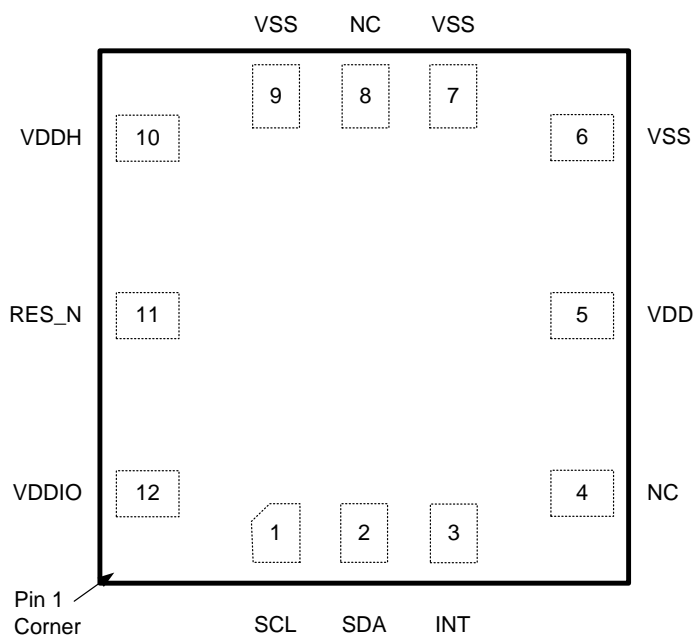


Figure 3. Pin Assignments – Top View

2.2 Pin Descriptions

Table 1. Pin Descriptions

| Pin Number | Name | Type | Description |
|------------|-------------------|--------------|---|
| 1 | SCL | Input | Serial clock for the I ² C interface. |
| 2 | SDA | Input/Output | Serial data for the I ² C interface. Default 7-bit slave address: 33 _{HEX} . |
| 3 | INT | Output | Interrupt signal (push-pull): <ul style="list-style-type: none"> ▪ HIGH when a measurement is running ▪ LOW when a measurement has finished Note: Use edge detection on falling edge. |
| 4 | NC | - | Do not connect. |
| 5 | V _{DD} | Supply | Voltage supply for the ZMOD4510. |
| 6 | V _{SS} | Ground | Ground reference for the ZMOD4510. |
| 7 | V _{SS} | Ground | Ground reference for the ZMOD4510. |
| 8 | NC | - | Do not connect. |
| 9 | V _{SS} | Ground | Ground reference for the ZMOD4510. |
| 10 | V _{DDH} | Supply | Voltage supply for the integrated heater in the ZMOD4510. |
| 11 | RES_N | Input | ZMOD4510 reset; active low. |
| 12 | V _{DDIO} | Supply | Voltage supply for I/O-interface in ZMOD4510. |

3. Specifications

3.1 Absolute Maximum Ratings

The absolute maximum ratings are stress ratings only. The ZMOD4510 may not be operable below and above the recommended operating conditions in Table 2. Stresses exceeding the absolute maximum ratings will change the sensor module accuracy; lead to imprecision, and eventually cause irreversible damage to the device. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. Renesas does not recommend designing to the “Absolute Maximum Ratings.”

Note: The reference for all voltages is V_{SS} .

Table 2. Absolute Maximum Ratings

| Symbol | Parameter | Minimum | Maximum | Unit |
|-----------------------------|---|---------|------------------|------|
| $V_{DD}, V_{DDH}, V_{DDIO}$ | Maximum Analog and I/O Supply Voltage | -0.4 | 3.63 | V |
| V_{A_IO}, V_{D_IO} | Maximum Voltage at all Analog and Digital I/O Pins | -0.5 | $V_{DDIO} + 0.5$ | V |
| - | Maximum Difference in Voltage between V_{DD} and V_{DDH} Pins | - | 0.4 | V |
| I_{IN} | Input Current into any Pin Except Supply Pins (Latch-Up Immunity) | -100 | 100 | mA |
| V_{HBM1} | Electrostatic Discharge Tolerance – Human Body Model (HBM) | - | 2000 | V |
| V_{CDM} | Electrostatic Discharge Tolerance – Charged Device Model (CDM) on Packaged Module | - | 1500 | V |
| T_{AMB} | Ambient Temperature Range for Sensor Module Operation | -40 | 65 | °C |
| T_{STOR} | Storage Temperature | -50 | 125 | °C |
| $T_{OPERATION}$ | Operation Temperature Sequence of Sensing Element ^[1] | - | 550 | °C |

1. Controlled via API in firmware and EVK software.

3.2 Electrical Specifications

The following values are valid at operating conditions unless noted otherwise.

Note: The reference for all voltages is V_{SS} .

Table 3. Electrical Specifications

| Symbol | Parameter | Conditions | Minimum | Typical | Maximum | Unit |
|----------------|---|--|--------------------|-------------------|--------------------|---------|
| V_{DD} | Recommended Supply Voltage | - | 1.7 | - | 3.6 | V |
| P_{AVG} | Average Power | NO2 O3 operation ^[1] , $V_{DD} = 1.8$ V | - | 3.90 | - | mW |
| | | ULP O3 operation ^[1] , $V_{DD} = 1.8$ V | - | 0.22 | - | mW |
| I_{PEAK} | Peak Supply Current, including Heater Current | $V_{DD} = 1.8$ V | - | 18 | - | mA |
| | | $V_{DD} = 3.3$ V | - | 23 | - | mA |
| I_{AVG} | Average Supply Current | NO2 O3 operation ^[1] , $V_{DD} = 1.8$ V | - | 2.17 | - | mA |
| | | NO2 O3 operation ^[1] , $V_{DD} = 3.3$ V | - | 2.18 | - | mA |
| I_{AVG} | Average Supply Current | ULP O3 operation ^[1] , $V_{DD} = 1.8$ V | - | 120 | - | μ A |
| | | ULP O3 operation ^[1] , $V_{DD} = 3.3$ V | - | 98 | - | μ A |
| I_{SLEEP} | Current during measurement delays | Sleep Mode ASIC | - | 450 | - | nA |
| PSRR | Power Supply Rejection Ratio | $V_{DD} \geq 2.0$ V | - | 30 | - | dB |
| - | Timing Accuracy (Valid for Measurements Only); (Sleep Timer is $\pm 20\%$) | At room temperature; for timings derived from the internal clock | -2 | - | 2 | % |
| | | Over-temperature range; for timings derived from the internal clock | -0.1 | - | 0.1 | %/K |
| r_{ADC} | ADC Resolution | - | 10 | - | 16 | Bit |
| t_{STA1} | Start-up Time: V_{DD} Ramp up to Interface Communication | - | - | - | 1 | ms |
| $f_{C,I2C}$ | I ² C Clock Frequency | - | - | - | 400 | kHz |
| t_{VPP} | NVM Programming Time | - | - | 6 | 16 | ms |
| t_{RET_FTP} | Data Retention | 85°C junction temperature | 10 | - | - | years |
| - | NVM Programming Cycles | | 1000 | - | - | cycles |
| - | Default I ² C Communication Address | 7-bit slave address | - | 33 _{HEX} | - | - |
| - | Blocking Capacitor for Power Supply | Ceramic type; recommended to be placed close to V_{DDH} of the gas sensor module | 100 | - | - | nF |
| VIH | Logic Voltage Level High | Applies for RES_N, SCL, and SDA | 0.7* V_{DDIO} | - | - | V |
| VIL | Logic Voltage Level Low | Applies for RES_N, SCL, and SDA | - | - | 0.3* V_{DDIO} | V |

1. Operation modes are described in "Description of Operation Modes and Related Outputs".

4. Description of Operation Modes and Related Outputs

The ZMOD architecture leverages different “Methods of Operation” (Operation Modes), which use time, temperature, and signatures from gases that enable unique signals from a highly trained machine learning system and makes use of embedded artificial intelligence (AI) technology. This section discusses the different operation modes of the ZMOD4510 as well as their corresponding outputs and properties. An overview is provided in Table 4.

The following operation modes and corresponding firmware packages are released ^[1]:

- NO2 O3 – Selective nitrogen dioxide and ozone firmware (recommended for new designs)
- ULP O3 – Selective ozone firmware for Ultra-Low Power operation

Note: On one physical device only one operation mode should run continuously. Switching of modes should not be done during device operation.

Table 4. Overview of Output and Properties for Different Operation Modes

| Operation Mode | Output | | | Properties | |
|----------------|----------------------------|-------------------------------------|--------------------------------------|-----------------------------|-----------------|
| | AQI rating | O₃ [ppb] | NO₂ [ppb] | Raw Resistance Signal [Ohm] | Ultra-low Power |
| NO2 O3 | ✓ | ✓ | ✓ | ✓ | - |
| ULP O3 | ✓ | ✓ | - | ✓ | ✓ |

By default, the NO2 O3 operation should be used for new designs due to best accuracy over wide NO₂ and O₃ detection range. Table 5 provides an overview of sample rate and the warm-up (stabilization) samples after each power-on for each operation mode. The warm-up times are fixed, and algorithm results should be considered only after the warm-up.

Table 5. Sample Rates and Warm-Up Samples for ZMOD4510 Operation Modes

| Operation Mode | Sample Rate [Seconds] | Warm-Up Samples Upon Start |
|----------------|-----------------------|----------------------------|
| NO2 O3 | 6 | 50 |
| ULP O3 | 2 | 900 |

The following sections provide information on nitrogen dioxide and ozone gases, gas concentrations, and thresholds given by the US Environmental Protection Agency (EPA). All graphs and information show the typical responses that are to be expected from the sensor module upon exposure to a variety of test conditions.

1. The previous OAQ 1st Generation operation mode is legacy and not recommended for new designs. OAQ 2nd Generation operation mode is renamed to ULP O3.

4.1 AQI Rating according to EPA

There are many sources of poor air that can elevate the Air Quality Index (AQI). Renesas has adopted the definition of Air Quality and its impact on user health and comfort proposed by the US Environmental Protection Agency (EPA); see Table 6. The ZMOD4510 can detect the presence of elevated nitrogen dioxide (NO₂) and ozone (O₃) levels as described by the EPA. Additional information on this topic, chemical background information, and measurement technologies are available in the Renesas white paper, [Overview Outdoor Air Quality](#).

Table 6. Air Quality Index Levels Described by the EPA [2]

| Air Quality Index (AQI) | Level of Concern and Air Quality Condition | O ₃ Concentration 1h Avg. [ppb] | O ₃ Concentration 8h Avg. [ppb] | NO ₂ Concentration 1h Avg. [ppb] | Color Code |
|-------------------------|--|--|--|---|------------|
| 0 to 50 | Good | 0 to 62 | 0 to 54 | 0 to 53 | Green |
| 51 to 100 | Moderate | 63 to 124 | 55 to 70 | 54 to 100 | Yellow |
| 101 to 150 | Unhealthy for Sensitive Groups | 125 to 164 | 71 to 85 | 101 to 360 | Orange |
| 151 to 200 | Unhealthy | 165 to 204 | 86 to 105 | 361 to 649 | Red |
| 201 to 300 | Very unhealthy | 205 to 404 | 106 to 200 | 650 to 1249 | Purple |
| 301 to 500 | Hazardous | 405 to 604 | - | 1250 to 2049 | Maroon |

The AQI output is according to the EPA standard, and is differentiated between 1 hour and 8 hours exposures (concentration dependent). Output based on these EPA criteria is called “EPA AQI” in the output files. However, for fast changing environments (e.g., during evaluation, testing, and system checks), it is recommended to use the “FAST AQI” signal, which is the same AQI calculation based on a 1-minute average. The algorithm is tailored for best accuracy in the typical environmental range of 20 to 100ppb and can report up to 500ppb. AQI values above 500 are considered beyond the AQI. ULP O3 operation mode will report AQI levels calculated from ozone concentrations and will not consider nitrogen dioxide in the calculation.

4.2 Nitrogen Dioxide and Ozone

The ZMOD4510 operates with an optimized temperature profile to detect signatures from gases. These unique signals are supplied to a highly trained machine learning system that uses of embedded artificial intelligence (AI) technology. These algorithms can differentiate and report nitrogen dioxide (NO₂ O₃ mode) and ozone concentrations (NO₂ O₃ mode and ULP O₃ mode). They are tailored to real-world applications with the appropriate concentrations. Figure 4 shows a typical course of nitrogen dioxide and ozone concentrations determined with the ZMOD4510 in a real-world environment with selective reference instrumentation.

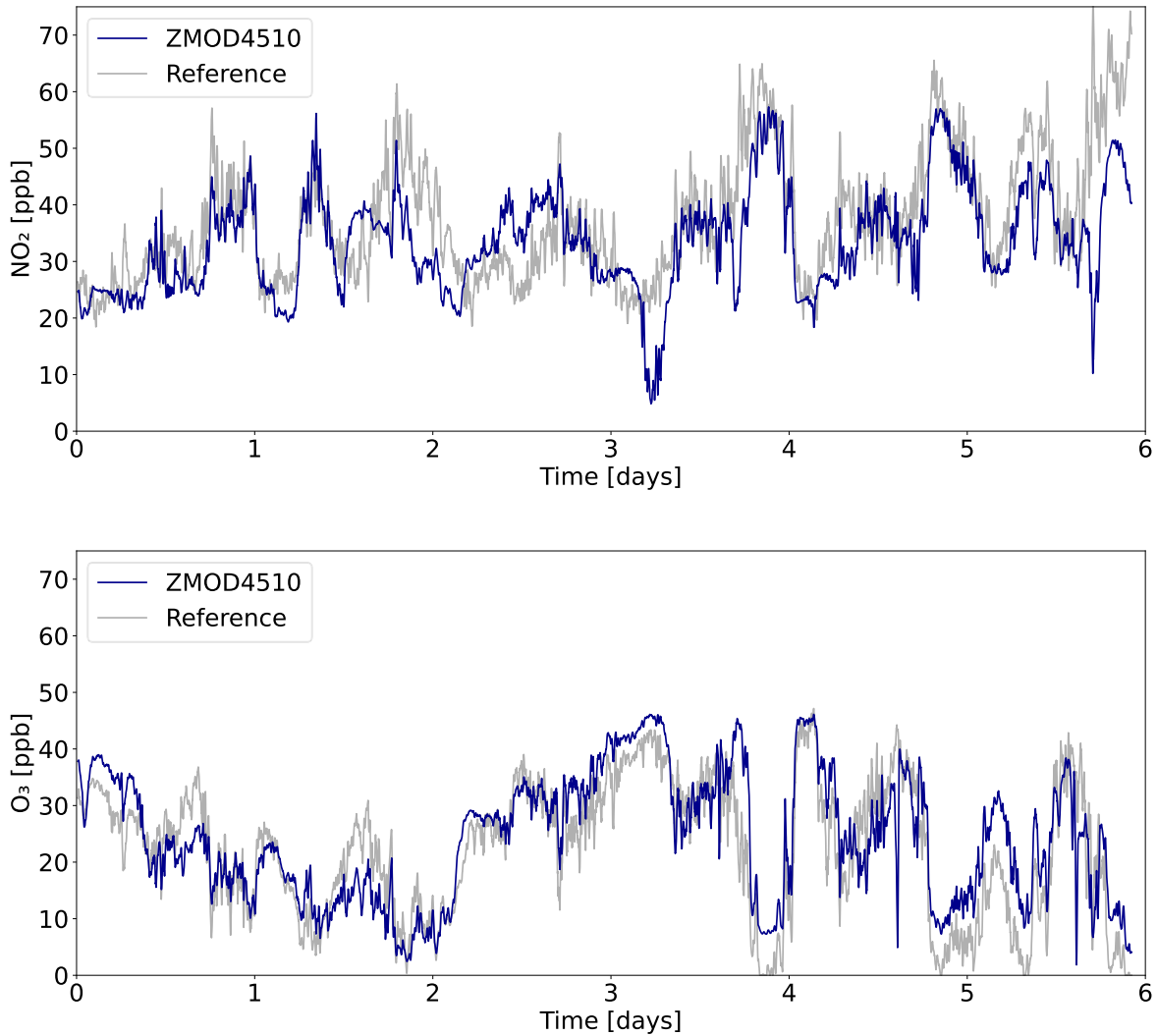


Figure 4. Nitrogen Dioxide and Ozone Course Compared to a Reference Instrument

4.3 Sensor Module Algorithm and Firmware

To operate the ZMOD4510, the software and libraries provided by Renesas should be used. The user's microcontroller must ensure the appropriate sample rate of 2 (ULP O₃) or 6 (NO₂ O₃) seconds. The algorithm always uses the raw output signals from the ZMOD4510, which are resistances, to determine the level of gases present. Depending on the microprocessor and compiler used, the firmware and its algorithms require 10 to 30kB flash size. All algorithms feature an automated baseline correction function, ensuring that the module can learn from its environment and distinguish elevated levels of gases under all conditions.

For implementing the sensor module in a customer-specific application, detailed information on the programming is available. More information and guidance on the firmware integration, architecture, and supported platforms are available in the *ZMOD4510 Programming Manual – Read Me*. Code examples in C and additional firmware descriptions for API, HAL, libraries, etc., are included in the downloadable firmware package from the [ZMOD4510](#) product page.

Note: Switching from OAQ 1st Gen operation (legacy firmware) mode to the current firmware is not possible on the same sensor module. A new sensor must be used in this case.

5. Gas Sensor Module Characteristics

This section describes general sensor module characteristics, like measurement and operational ranges. In addition, details for accuracy, sensitivity, reliability, sample rates, and sensor module influences are explained. All graphs and information show the typical responses that are to be expected from the sensor module upon exposure to a variety of test conditions. For more information, including application notes, white papers, blog, and manuals, visit the [ZMOD4510](#) product page.

5.1 General Characteristics

The ZMOD4510 uses a sequence of applied temperatures to sample the air and report nitrogen dioxide concentration, ozone concentration, and a resulting Air Quality Index (AQI) based on the EPA standard ^[2]. An additional temperature and humidity measurement is recommended, and the algorithm has an auto-compensation included. If no temperature and humidity data are provided as input, the algorithm will use default values, which may lead to an offset of ± 1 EPA level according to Table 6. The sensor does not require an active or direct airflow onto the sensor module because diffusion of ambient gas does not limit the sensor response time. Characteristic module parameters are shown in Table 7.

Important: The ZMOD4510 can also detect safety-relevant gases; however, the sensor module is not designed to detect these interferants reliably and therefore it is not approved for use in any safety-critical or life-protecting applications. It must not be used in such applications, and Renesas disclaims all liability for any such use.

Table 7. Gas Sensor Module Characteristics

| Symbol | Parameter | Conditions | Minimum | Typical | Maximum | Unit ^[1] |
|--------|-------------------|--|---------|---------|---------|---------------------|
| AQI | Air Quality Index | Rating according to EPA for nitrogen dioxide and ozone | 0 | - | 500 | - |
| - | Measurement Range | Nitrogen dioxide (NO ₂ O ₃ operation) | 20 | - | 500 | ppb |
| | | Ozone | 20 | - | 500 | ppb |
| - | Cross sensitivity | NO ₂ O ₃ operation, 200ppb ozone | - | 15 | - | AQI level |
| | | NO ₂ O ₃ operation, 200ppb nitrogen dioxide | - | 10 | - | AQI level |
| | | ULP O ₃ operation, Ozone reporting at 200ppb nitrogen dioxide | - | 25 | - | AQI level |
| RH | Humidity Range | Indoor, Non-condensing | 30 | - | 60 | % RH |
| | | Outdoor, Non-condensing | 10 | - | 90 | % RH |
| T | Temperature Range | Indoor, Typical environment | 10 | - | 40 | °C |
| | | Outdoor, Typical environment | -20 | - | 50 | °C |
| | | Extended range | -40 | - | 65 | °C |

1. The abbreviation ppb stands for “parts per billion” and is a molar ratio with the exponent of 10^{-9} .

5.2 Accuracy and Consistency

All Renesas gas sensor modules come with electrical and chemical factory calibration with data stored in the module’s nonvolatile memory (NVM). Using the software provided by Renesas and the calibration coefficients in

² AirNow, US Environmental Protection Agency, Air Quality Index (AQI) Basics; available at: <https://www.airnow.gov/aqi/aqi-basics/>

the NVM will result in stable measurements of the nitrogen dioxide, ozone concentrations, and AQI levels discussed in section 4.1. Typical achievable sensor module performance is displayed in Table 8.

Table 8. Typical ZMOD4510 Sensor Module Performances

| | Parameter | Conditions | Gas | Typical | Unit |
|--------------------|----------------------------|---|--|---------|------|
| Outdoor Monitoring | Accuracy ^[1] | 23°C and 30% RH, 0 to 500 ppb | Nitrogen dioxide (only NO2 O3 operation) & Ozone (all modes) | ±50 | AQI |
| | Consistency ^[2] | | | ±50 | |
| Indoor Monitoring | Accuracy ^[1] | NO2 O3 operation, 23°C and 30% RH, 0 to 100 ppb | Nitrogen dioxide | ±20 | ppb |
| | | | Ozone | ±10 | |
| | Consistency ^[2] | | Nitrogen dioxide | ±10 | |
| | | | Ozone | ±5 | |

1. Without additional calibration.
2. Part-to-Part variation.

5.3 Conditioning and Sensor Self-Check Status

The cleaning conditions the sensor material and helps to remove contaminants (e.g., solder flux and vapours). The cleaning process takes 1 minute. Cleaning can only be performed once during the lifetime of the sensor and is recommended after PCB assembly (e.g., during final production test or at the end customer). The cleaning function automatically ensures that cleaning is performed only once. This is done by writing a control bit into the sensor module's NVM. It is important not to interrupt the cleaning process while it is running.

The ZMOD4510 will respond to ozone and nitrogen dioxide immediately upon start-up; however, a conditioning period of at least 48 hours of continuous operation in an ambient environment is recommended to improve stability and obtain maximum performance.

The sensor module has a self-check for its general functionality. With every measurement the algorithm performs an internal check of resistances to identify potential damage, and the ZMOD4510 measurement output contains a sensor self-check status with either warm-up, valid, or damage. The following are possible reasons for the error:

- Improper or open solder contacts
- High contamination on sensor material surface
- Broken MEMS membrane
- MOx material delamination
- Oxygen depletion on sensor surface
- Sometimes a stimulation with extremely high gas concentrations can cause a damage error output

The following measures can solve this issue:

- Check your production to ensure proper soldering. Use a proper soldering paste with correct temperature profile (see “Assembly Restrictions, Operation, Integration Notes, and Storage”).
- Find the source of sensor surface contamination during production (e.g., solder vapors, cleaning chemicals) and try to avoid them. Make sure to have executed the cleaning procedure after the assembly.
- Make sure the sensor module’s vent hole is not blocked because of protection paints or high dust/dirt accumulation.
- Do not use or store the sensor in an atmosphere without oxygen (e.g., pure nitrogen).

5.4 Environmental Influences

The sensor module is tested, qualified, and functional in the operation range of -40°C to +65°C. Temperature or relative humidity compensation are not required but are recommended for best performance. Use a humidity and temperature sensor in conjunction with the ZMOD4510 whenever possible. If relative humidity and temperature values are provided to the algorithm, the ZMOD4510 automatically uses these values for compensation. If no humidity and temperature sensor is available, provide the algorithm with the default values, RH = 50% and temperature = -300°C. This sets a default humidity value for the algorithm and enables the internal temperature measurement of the ZMOD4510. If no temperature or humidity data are provided the algorithm will use default values, which may lead to an offset of ± 1 EPA level according to Table 6.

For some environments, an interference response to siloxanes is of concern; however, the ZMOD4510 has been proven to be resistant against siloxanes. A maximum potential life-time exposure has been simulated in all ZMOD4510 operation modes by applying the chemicals D4 (Octamethylcyclotetrasiloxane) and D5 (Decamethylcyclopentasiloxane) in high concentration. Change in sensitivity during 15,000 ppm·h exposure with D4 and D5 is typically 8%.

6. Assembly Restrictions, Operation, Integration Notes, and Storage

When implementing the ZMOD4510 in electrical circuit boards, a gas sensor module may react to chemicals during the assembly process and to outgassing components, such as resins from the printed circuit board (PCB) assembly. A standard soldering profile can be used to assemble the ZMOD4510 on the user's PCB and should fulfill the IPC/JEDEC J-STD-020C Standard ("Moisture/Reflow Sensitivity Classification for Non-hermetic Solid State Surface Mount Devices"). A typical lead-free reflow solder profile is shown in Figure 3. After assembly, an outgassing of the PCB and electronic components must be considered, especially when operating the sensor module at elevated temperatures. This will ultimately influence the sensor signal and accuracy.

A PCB heat treatment before assembling the ZMOD4510 is recommended. After the gas sensor module assembly, no coating, cleaning, or ultrasonic bath should be applied to the PCB. Also, sensor module parts should be cleaned after assembly by using the cleaning library provided with the firmware to remove contamination of solder vapor or from storage from the MOx surface. If the sensor module does not show full performance after a cleaning cycle, a change to the protection sticker package is recommended (see Ordering Information).

Store the sensor module in an antistatic metallic bag with a low VOC background after the sensor module is removed from its original packaging or the assembled PCB is populated. The optimal storage conditions are < 1ppm TVOC, < 10ppb O₃, < 10ppb NO₂, 10°C to 50°C, and humidity levels within 20% to 80%RH. If the sensor module is stored outside of these conditions for extended periods of time, the sensor module readings can exhibit a temporary offset. The sensor module can be reconditioned and brought back to its calibration state by operation for 24 hours to 48 hours in clean air.

To receive the *Renesas Gas Sensor Guidelines* with detailed information and on assembly, material outgassing, test and validation procedures, contact Renesas via the contact information on the last page.

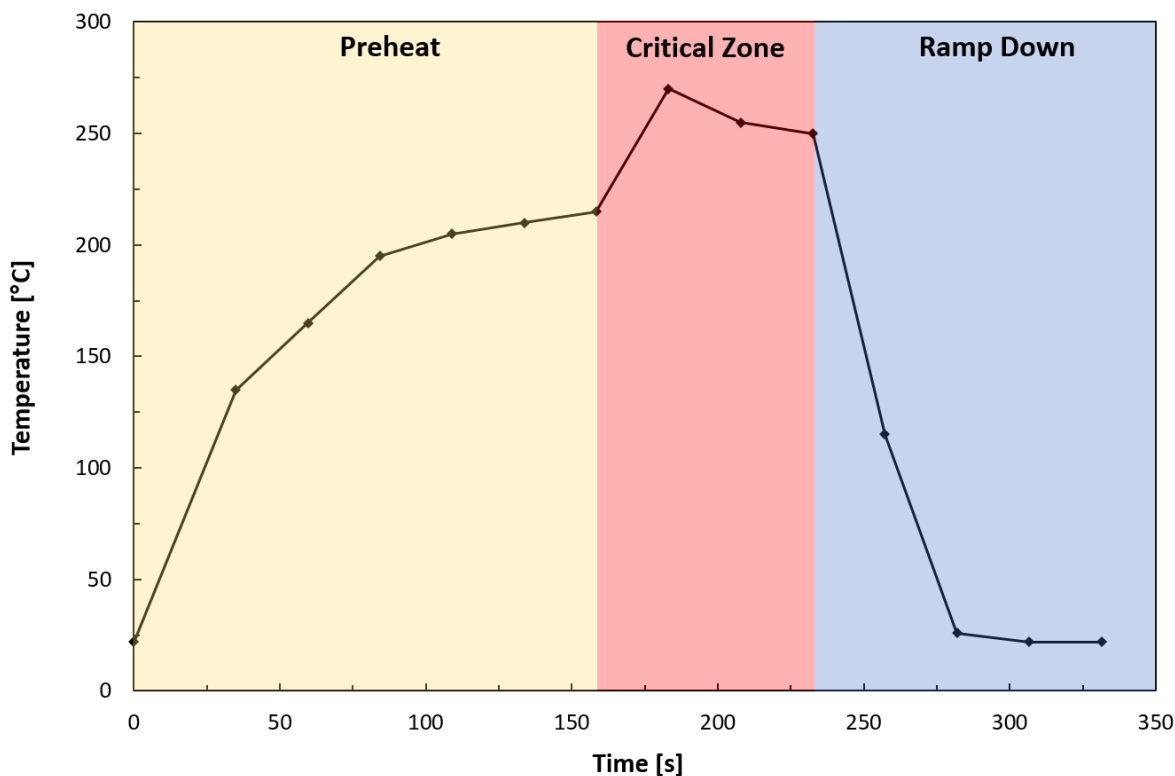


Figure 5. Typical Solder Profile

7. Test and Calibration

As a unique feature, all sampled gas sensor modules are fully tested during Renesas’ final test. The final test parameters in Table 9 are applied for each ZMOD4510. All sensor modules are pre-stabilized in the final test although the user may see a slight change in the module’s raw signal during an initial warm-up phase during the first operation. The gas sensor module qualification is based on JEDEC (JESD47) and its subsequent standard (JESD22, JESD78, etc.); it has been tested for a lifetime of 10 years. Renesas has proven a MOx lifetime of over 20+ years in actual continuous operation in conditions without exposures to stressful environments.

Table 9. Final Test Parameters

| Test | Test Object | Parameters | Test Results Saved in NVM? |
|------------|-------------|---|----------------------------|
| Electrical | ASIC | Voltages, current consumption, frequencies, scan pattern | No |
| Electrical | Module | Calibration conditions, tracking ID, resistances | Yes |
| Gas | Module | Sensitivity parameters (slope and intercept) at stimulation with different gas concentrations | Yes |
| Gas | Module | Pre-stabilization | No |

8. I²C Interface and Data Transmission Protocol

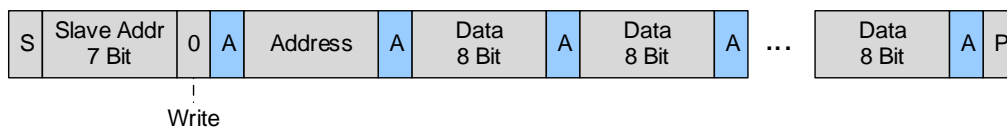
The I²C slave device interface supports various bus speeds: Standard Mode ($\leq 100\text{kHz}$) and Fast Mode ($\leq 400\text{kHz}$).

By default, the 7-bit slave address for the serial I²C data interface is set to 33_{HEX}. The implemented data transmission protocol is similar to the one used for conventional EEPROM devices. The register to read/write is selected by a register address pointer. This address pointer must be set during an I²C write operation. For read access a repeated START condition but no STOP condition should be sent. After transmission of a register, the address pointer is automatically incremented. A STOP condition ends the whole transmission. An increment from the address FF_{HEX} rolls over to 00_{HEX}.

For an example of the I²C data transmission protocol, see Figure 6. For information on I²C bus timing, see Figure 7. For I²C bus characteristics, see Table 10, which explains how to set up the interface. All other values are according to the I²C standard. Although the ZMOD4510 has an I²C interface, the user is not intended to modify any registers because a configuration change will affect the sensor module's performance, reliability, and accuracy. The API provided with the downloadable firmware package on the website manages all necessary sensor module communication.

To validate the general MCU-specific I²C read/write driver without the use of Renesas firmware, it is possible to write random values to registers 0x88 to 0x8B and read them afterwards. After this register testing, erase the testing code and reset the device by disconnecting the power support; otherwise the device may not operate properly.

WRITE Access RAM



READ Access NVM and RAM

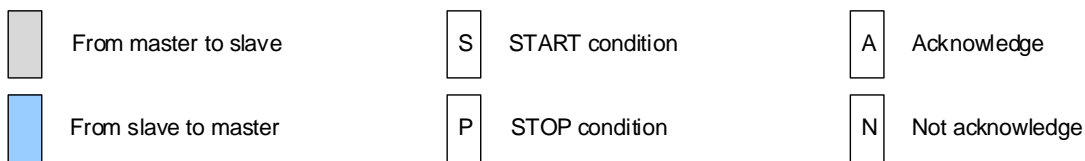
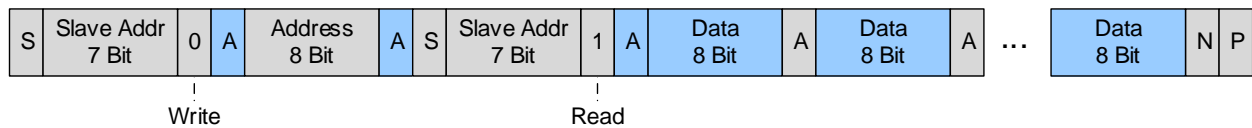


Figure 6. I²C Data Transmission Protocol

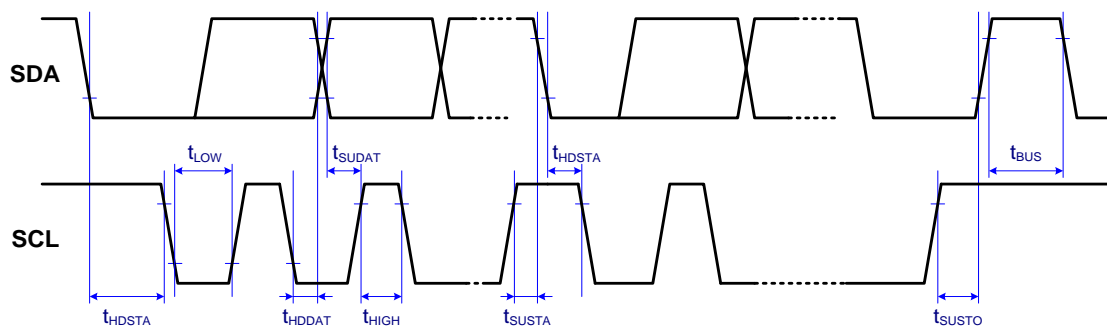


Figure 7. Bus Timing

Table 10. Bus Timing Characteristics

| Symbol | Parameter | Standard Mode | Fast Mode | Units |
|--------------------|--|---------------|-----------|-------|
| f _{SCL} | Maximum SCL clock frequency | 100 | 400 | kHz |
| t _{HDSTA} | Minimum START condition hold time relative to SCL edge | 4 | - | μs |
| t _{LOW} | Minimum SCL clock low width | 4.7 | - | μs |
| t _{HIGH} | Minimum SCL clock high width | 4 | - | μs |
| t _{SUSTA} | Minimum START condition setup time relative to SCL edge | 4.7 | - | μs |
| t _{HDDAT} | Minimum data hold time on SDA relative to SCL edge | 0 | - | μs |
| t _{SUDAT} | Minimum data setup time on SDA relative to SCL edge | 0.1 | 0.1 | μs |
| t _{SUSTO} | Minimum STOP condition setup time on SCL | 4 | - | μs |
| t _{BUS} | Minimum bus free time between stop condition and start condition | 4.7 | - | μs |

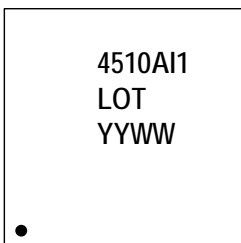
9. Package Outline Drawings

The ZMOD4510's different packages are listed in Table 11.

Table 11. Package Options

| Part Number | Version | Comment | Package Link |
|-------------|----------------------|--|---|
| ZMOD4510AI1 | Standard | Standard package. | 3.0 × 3.0 × 0.7 mm, LGG12D1 |
| ZMOD4510AI2 | Sticker | This package shipped with a sticker on top of the lid to protect sensor during assembly. Note, the sticker must be removed after assembly. | |
| ZMOD4510AI3 | Waterproof | This package uses a membrane to get IP67 rating. | 3.0 × 3.0 × 0.9 mm, LGG12D2 |
| ZMOD4510AI4 | Waterproof + Sticker | This package uses a membrane to get IP67 rating and is shipped with a sticker on top of the lid to protect sensor during assembly. Note, the sticker must be removed after assembly. | |

10. Marking Diagram



- Line 1 is the truncated part number.
- Line 2 – “LOT” denotes the assembly lot number.
- Line 2 – “YYWW” are the last two digit of the year and week that the part was assembled.

11. Ordering Information

| Part Number | Description and Package | MSL Rating | Carrier Type | Temp. Range |
|-----------------|--|------------|--------------|---------------|
| ZMOD4510AI1V | ZMOD4510 Sensor Module, 3.0 × 3.0 × 0.7 mm 12-LGA | 3 | Tray | -40° to +65°C |
| ZMOD4510AI1R | ZMOD4510 Sensor Module, 3.0 × 3.0 × 0.7 mm 12-LGA | 3 | Reel | -40° to +65°C |
| ZMOD4510AI2V | ZMOD4510 Sensor Module, 3.0 × 3.0 × 0.7 mm 12-LGA , shipped with removable protection sticker | 3 | Tray | -40° to +65°C |
| ZMOD4510AI2R | ZMOD4510 Sensor Module, 3.0 × 3.0 × 0.7 mm 12-LGA , shipped with removable protection sticker | 3 | Reel | -40° to +65°C |
| ZMOD4510AI3V | ZMOD4510 Sensor Module, 3.0 × 3.0 × 0.9 mm 12-LGA , IP67 rating | 3 | Tray | -40° to +65°C |
| ZMOD4510AI3R | ZMOD4510 Sensor Module, 3.0 × 3.0 × 0.9 mm 12-LGA , IP67 rating | 3 | Reel | -40° to +65°C |
| ZMOD4510AI4V | ZMOD4510 Sensor Module, 3.0 × 3.0 × 0.9 mm 12-LGA , shipped with removable protection sticker and IP67 rating | 3 | Tray | -40° to +65°C |
| ZMOD4510AI4R | ZMOD4510 Sensor Module, 3.0 × 3.0 × 0.9 mm 12-LGA , shipped with removable protection sticker and IP67 rating | 3 | Reel | -40° to +65°C |
| ZMOD4510-EVK-HC | ZMOD4510 Evaluation Kit including the ZMOD4510 Sensor Board, ESCOM Communication Board (USB Interface) and Micro-USB Cable. The Gas Sensor Evaluation Software is available for download free of charge on ZMOD4510 Evaluation Kit product page. | | | |

12. Related Information

Visit the [ZMOD4510](#) and [ZMOD4510 Evaluation Kit](#) (ZMOD4510-EVK) product pages on the Renesas website to download software and the latest version of related documents, such as application notes, white papers, product briefs, and third-party reports.

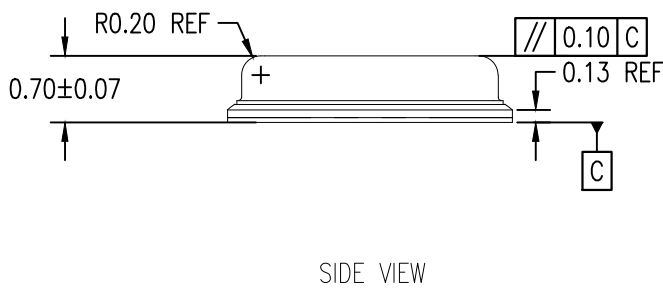
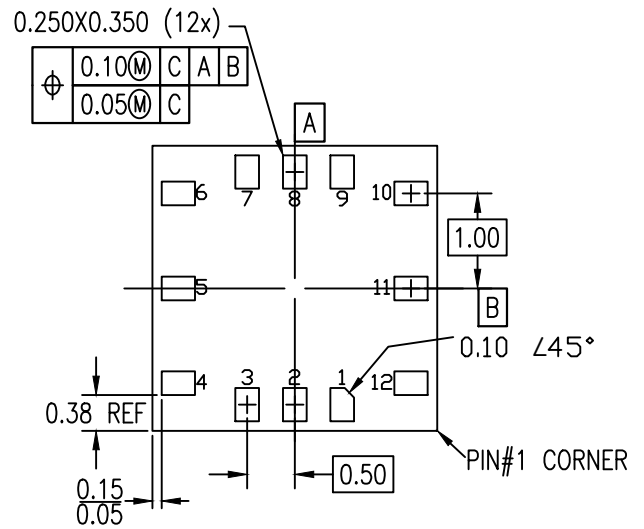
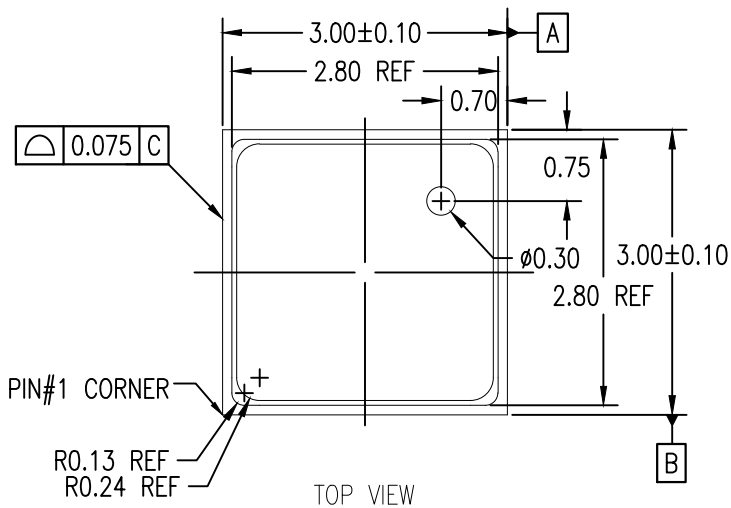
Note that some documents require logging in with a free customer account, which can be set up under the “LOG IN” button on the website. Some downloads require an additional step to complete a request form that appears when the link is clicked.

13. Glossary

| Term | Description |
|-----------------|---------------------------------------|
| ADC | Analog-to-Digital Converter |
| AI | Artificial Intelligence |
| AQI | Air Quality Index |
| CDM | Charged Device Model |
| CM | Common Mode Generator |
| EPA | Environmental Protection Agency (USA) |
| HBM | Human Body Model |
| LGA | Land Grid Array |
| LV | Low Voltage |
| MCU | Microcontroller Unit |
| MOx | Metal Oxide |
| MSL | Moisture Sensitivity Level |
| Mux | Multiplexer |
| n.a. | Not Applicable |
| NO ₂ | Nitrogen Dioxide |
| NVM | Nonvolatile Memory |
| O ₃ | Ozone |
| POR | Power-On Reset |
| RH | Relative Humidity |
| SDA | Serial Data |
| SCL | Serial Clock |
| SSC | Sensor Signal Conditioner |
| TST | Test |
| TVOC | Total Volatile Organic Compounds |

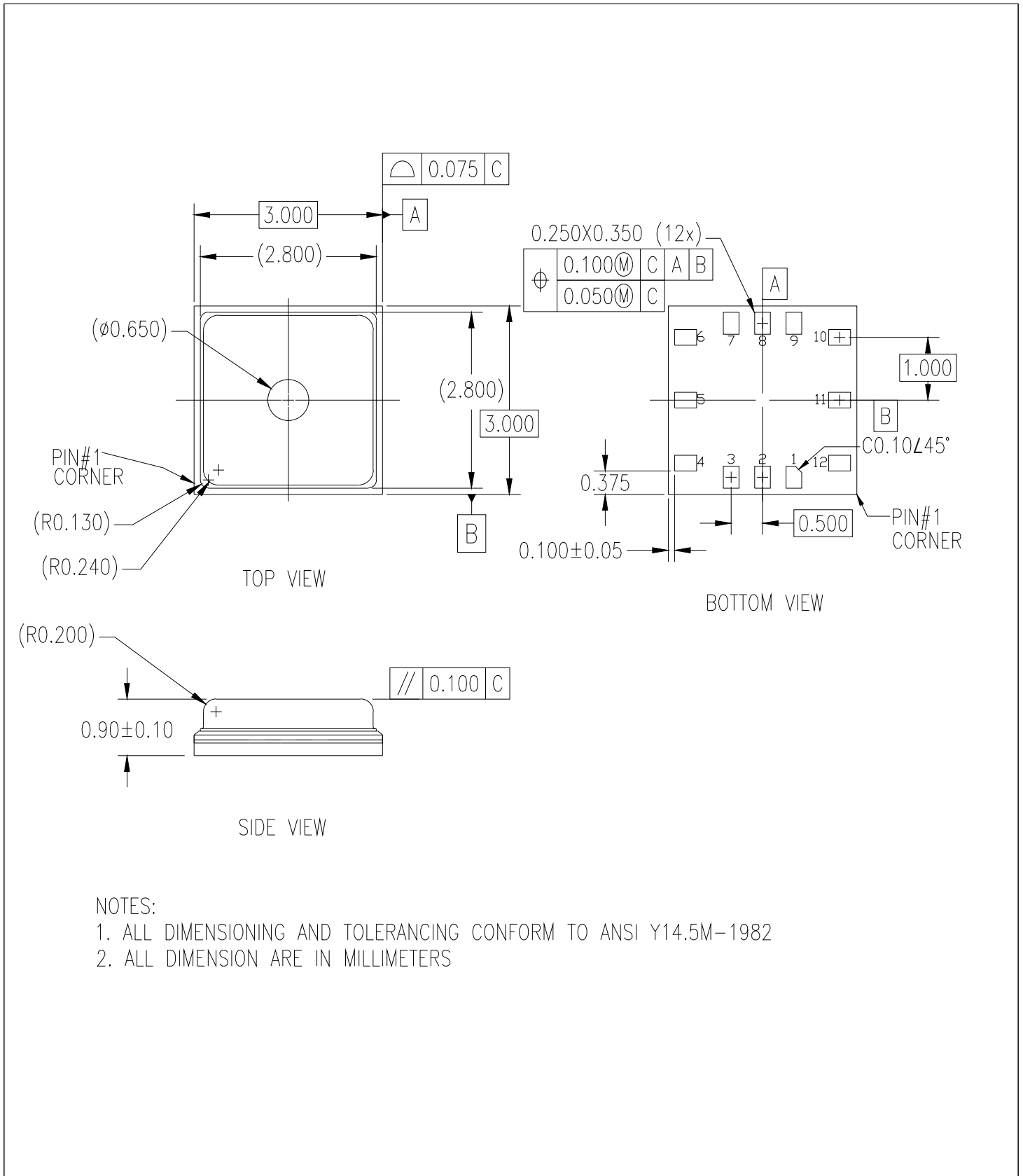
14. Revision History

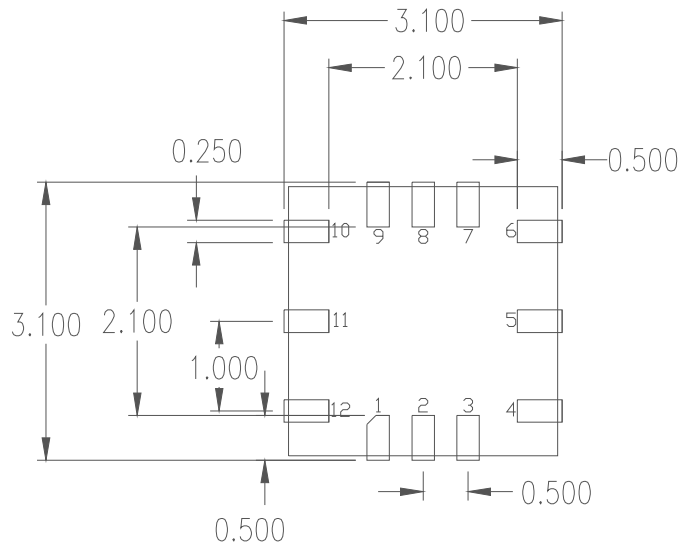
| Revision | Date | Description |
|----------|--------------|--|
| 1.04 | May 30, 2024 | <ul style="list-style-type: none">▪ Replaced OAQ 1st Gen with NO2 O3 operation mode.▪ Renamed OAQ 2nd Gen to ULP O3.▪ Added "Conditioning and Sensor Self-Check Status".▪ Completed minor changes throughout.▪ Migrated the document to the latest template. |
| - | Jun 30, 2021 | <ul style="list-style-type: none">▪ Added an explanation of EPA AQI and FAST AQI.▪ Corrected the part numbers in Package Options. |
| - | May 20, 2021 | <ul style="list-style-type: none">▪ Added OAQ 2nd Gen and Package options.▪ Completed minor changes throughout. |
| - | Feb 7, 2020 | <ul style="list-style-type: none">▪ Added ROHS compliance.▪ Updated NVM data space.▪ Updated on temperature measurements. |
| - | Sep 9, 2019 | <ul style="list-style-type: none">▪ Initial release. |



NOTES:

1. ALL DIMENSIONING AND TOLERANCING CONFORM TO ANSI Y14.5M-1982
2. ALL DIMENSION ARE IN MILLIMETERS.
3. UNLESS SPECIFIED, THE TOLERANCE OF ± 0.05 MM APPLIES TO DIMENSIONS OF 2 DECIMALS, AND ± 0.012 MM APPLIES TO DIMENSIONS OF 3 DECIMALS.





RECOMMENDED LAND PATTERN DIMENSION

NOTES:

1. ALL DIMENSION ARE IN MM. ANGLES IN DEGREES
2. TOP DOWN VIEW ON PCB
3. LAND PATTERN RECOMMENDATION PER IPC-7351B GENERIC REQUIREMENT FOR SURFACE MOUNT DESIGN AND LAND PATTERN

| Date Created | Rev No. | Package Revision History |
|----------------|---------|--------------------------|
| April 24, 2020 | Rev 00 | Initial release |

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